IPC ASSOCIATION ELECTRONICS	Material Con© Copyright 200 international and	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					rials and M	ials and Mfg Information			
upplier	Information						·								
Company name* Company unique ID					Unique ID Authority				Response Date*						
nsemi											2023-06-08				
Contact Na	me	Title - Conta	Title - Contact			Phone - Contact*				Email - Contact*					
Product-Er	nv-Stewards		Product Env	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
uthorized	Representative*	Title - Repre	Title - Representative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product Env				ct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr		tem Number Mfr Item Name				Effective Date Version Manuf		Manufacturing Site	e Weight*		UOM	Unit Type		
		LC717A10PJ-AH Touch Sensor 16		Touch Sensor 16C	Н	2023-06-0		PHM			130.0	mg	Each		
<b>I</b> anufact	turing Proccess Infor	nation						·							
Т	Terminal Plating / Grid Array Material			Ferminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperat				ure Numb	per of Reflow Cyc	eles		
contains Bi		CU Alloy 3			260	C		30	seconds 3						
omments															
<b>LIENTIC</b>	ON: MSL 3 Rated item requ	iires Bake and I	Ory Pack (afte	er electrical test)											
or more in	nformation regarding mater	rial composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appli											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.44	mg	Supplier	Silicon (Si)	7440-21-3		1.4308	mg
			Supplier	Polyimide	Proprietary Data		0.0092	mg
Die Attach	0.39	mg	Supplier	Silver (Ag)	7440-22-4		0.2769	mg
			Supplier	Epoxy resins	129915-35-1		0.1131	mg
Lead Frame	6.59	mg	Supplier	Zinc (Zn)	7440-66-6		0.0125	mg
			Supplier	Iron (Fe)	7439-89-6		0.1707	mg
			Supplier	Copper (Cu)	7440-50-8		6.3976	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0092	mg
Mold Compound-Black	119.38	mg		Phenolic Resin	proprietary data		5.969	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		3.3426	mg
			Supplier	Carbon Black (C)	1333-86-4		1.1938	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		3.5814	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		95.504	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		9.5504	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.2388	mg
Plating	1.84	mg	В	Bismuth (Bi)	7440-69-9		0.011	mg
			Supplier	Tin (Sn)	7440-31-5		1.829	mg
Wire Bond	0.36	mg	Supplier	Palladium (Pd)	7440-05-3		0.0036	mg
			Supplier	Gold (Au)	7440-57-5		0.3564	mg